

DATA SHEET

SKY65346-21: 900 MHz Transmit/Receive Front-End Module

Applications

· Automated meter reading

Features

- · Externally available bias circuits
- Control logic
- Cascaded receive gain: 12.4 dB
- Cascaded Noise Figure: 2.4 dB
- Transmit power: +26 dBm
- · Single DC supply
- · Shutdown mode
- Small, MCM (26-pin, 5 x 5 mm) package (MSL3, 260 °C per JEDEC J-STD-020)



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Description

The SKY65346-21 is a high-performance transmit/receive (T/R) front-end module (FEM) ideally suited for use in 900 MHz Industrial, Scientific, and Medical (ISM) applications.

A double-pole, double-throw (DPDT) switch allows the device to select between two antenna ports (ANT1 and ANT2 pins) for the transmit or receive path. A single-pole, double-throw (SPDT) switch selects which signal path is routed to the transceiver port (RFIO pin). The receive path has a low-noise amplifier (LNA) bypass switch.

The power amplifier (PA) and LNA biasing can be independently controlled with an external bias resistor. The device has a shutdown mode to minimize power consumption. All eight operating modes are controlled using three digital input pins (CTL1, CTL2, and CTL3).

The SKY65346-21 T/R FEM is provided in a compact, 26-pin 5×5 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

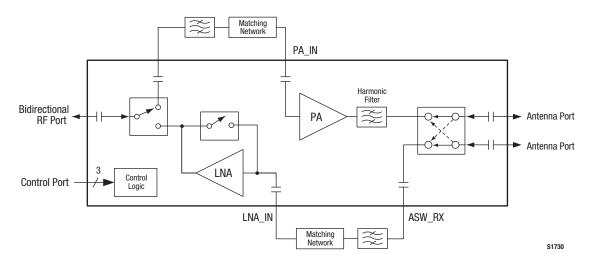


Figure 1. SKY65346-21 Block Diagram

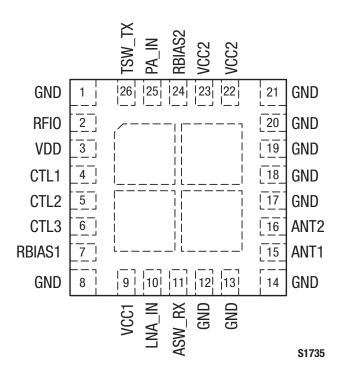


Figure 2. SKY65346-21 Pinout (Top View)

Table 1. SKY65346-21 Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	14	GND	Ground
2	RFI0	RF transceiver port	15	ANT1	Antenna port
3	VDD	Digital power supply	16	ANT2	Antenna port
4	CTL1	Digital control line	17	GND	Ground
5	CTL2	Digital control line	18	GND	Ground
6	CTL3	Digital control line	19	GND	Ground
7	RBIAS1	LNA external bias resistor	20	GND	Ground
8	GND	Ground	21	GND	Ground
9	VCC1	LNA power supply	22	VCC2	PA power supply
10	LNA_IN	LNA input port. Internally matched to 50 Ω .	23	VCC2	PA power supply
11	ASW_RX	Antenna switch receive port	24	RBIAS2	PA external bias resistor
12	GND	Ground	25	PA_IN	PA input port
13	GND	Ground	26	TSW_TX	Transceiver switch transmit port

Functional Description

The SKY65346-21 provides input and output amplifier stages, and is internally matched for optimum efficiency. An active bias circuit provides both input and output stages with excellent gain tracking over temperature and voltage variations. The module operates with positive DC voltages, and maintains high efficiency and good linearity. The nominal operating voltage is 3.3 V for maximum power. The PA and LNA biasing can be independently controlled with an external bias resistor.

Operational Modes

By using three control signals (CTRL1, CTRL2, and CTRL3), the SKY65346-21 can be configured to one of eight operational modes:

- Receive ANT1 bypass. In this mode, a low-loss broadband, bidirectional RF path allows easy switching of the signal between the transceiver and antenna port 1.
- Receive ANT2 bypass. In this mode, a low-loss broadband, bidirectional RF path allows easy switching of the signal between the transceiver and antenna port 2.
- Receive ANT1. In this mode, the SKY65346-21 amplifies the received signal at antenna port 1 through the LNA.

- Receive ANT2. In this mode, the SKY65346-21 amplifies the received signal at antenna port 2 through the LNA.
- Transmit ANT1. In this mode, the transmit path provides an harmonic filter and high efficiency PA on the Antenna 1 Port.
- Transmit ANT2. This is the same mode of operation as Transmit ANT1 except that the output is the Antenna 2 Port.
- Shut down (2). In this mode, the PA and LNA are powered down for minimal current consumption and low leakage current (<1 μA).

Table 2 provides the control logic for each of the eight operational modes.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY65346-21 are provided in Table 3 and the recommended operating conditions in Table 4. Electrical characteristics for the SKY65346-21 are provided in Table 5 through Table 10.

Typical performance characteristics of the SKY65346-21 are illustrated in Figures 3 through 27.

Table 2. SKY65346-21 Truth Table

	Control Voltage ¹			Internal States						
Operation Mode	CTL1 (Pin 4)	CTL2 (Pin 5)	CTL3 (Pin 6)	LNA On	PA On	RFI0 Switch	ANT1 Switch	ANT2 Switch		
Receive ANT1 bypass	1	1	1	off off			off off	-44	ASW_RX	Transmit PA
Receive ANT2 bypass	1	1	0	OH	OII	Receive LNA	Transmit PA	ASW_RX		
Receive ANT1	1	0	1		off		ASW_RX	Transmit PA		
Receive ANT2	1	0	0	on	OII			Tuon one it DA	ACW DV	
Transmit ANT1	0	1	1			Transmit PA	ASW_RX			
Transmit ANT2	0	1	0	off on	TSW_TX	ASW_RX	Transmit PA			
Shut down	0	0	0		off	open	open	open		
Shut down ²	0	0	1	off	off	open	open	open		

See Table 4 for logic 0 and logic 1 characteristics.

 $^{^2}$ In the high state, the CTL3 pin has an input current of 33 μ A due to an internal 100 $k\Omega$ pulldown. This mode is not recommended for lowest leakage current.

Table 3. SKY65346-21 Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
LNA supply voltage (VCC1)	Vcc1	-0.3	+5.0	V
PA supply voltage (VCC2)	Vcc2	-0.3	+5.0	V
Digital supply voltage (VDD)	VDD	-0.5	4.6	V
Digital input voltage (CTL1, CTL2, CTL3)	Vctl	-0.5	VDD + 0.3	V
LNA supply current (VCC1)	lcc1		20	mA
PA supply current (VCC2)	lcc2		500	mA
Receive RF input power	Pin_lna		+10	dBm
Transmit RF input power	PIN_PA		+10	dBm
Antenna port load VSWR (Note 2)			10:1	-
Operating case temperature	Tc	-40	+85	°C
Junction temperature	TJ		+150	°C
Storage case temperature	Тѕтс	-55	+150	°C

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 4. SKY65346-21 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Units
LNA supply voltage (VCC1)	Vcc1	2.7	3.3	3.7	V
PA supply voltage (VCC2)	Vcc2	2.7	3.3	3.7	V
Digital supply voltage (VDD)	V _{DD}	2.7	3.3	3.6	V
Digital input voltage, logic 0 (CTL1, CTL2, CTL3)	VCTL	0		0.2	V
Digital input voltage, logic 1 (CTL1, CTL2, CTL3)	VCTL	VDD - 0.2	V _{DD}	3.6	V
Receive RF input power (ANT1, ANT2)	PIN_RX			-10	dBm
Transmit RF input power (RFIO)	PIN_TX	-10	-6	+2	dBm
LNA external bias resistor	RBIAS1	3.3	4.7	33	kΩ
PA external bias resistor	RBIAS2	3.3	12	33	kΩ
915 MHz ISM band frequency range	FB915	902	915	928	MHz

 $^{^{2}}$ Antenna port load VSWR is limited by voltage. An open load condition will not damage the device.

Table 5. SKY65346-21 DC Electrical Specifications 1,2 (VCC1 = VCC2 = VDD = 3.3 V, Tc = -40 to +85 °C, f= 928 MHz, CW Input, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Quiescent current, receive mode ³	IQ_RX		5.0	6.7	10.0	mA
Operating current, receive mode ³	lop_rx		5.0	6.7	10.0	mA
Quiescent current, transmit mode ³	Іо_тх		70	78	90	mA
Operating current, transmit mode ³	lop_tx	PIN = -6 dBm		223	300	mA
Quiescent current, receive bypass mode ³	IQ_RXB			75		μΑ
Quiescent current, shutdown mode ^{3, 4}	IQ_SD			0.025		μΑ
Digital input current: ⁴ Logic 1 Logic 0	н L			33 0		μΑ μΑ

¹ Performance is guaranteed only under the conditions listed in this table.

Table 6. SKY65346-21 Electrical Specifications: LNA_IN to RFIO Receive Path (Note 1) (Note 2) (Note 3) (VCC1 = VCC2 = VDD = 3.3 V, Tc = $-40 \text{ to } +85 ^{\circ}\text{C}$, f= 928 MHz, CW Input, Unless Otherwise Noted)

•	•	• •		•		
Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Small signal gain	GLNA		10.5	13.7	15.5	dB
Noise Figure	NFLNA	100 kHz bandwidth		1.6	2.4	dB
1 dB input compression point	IP1dBLNA	1 dB gain compression	-13.0	-10.7		dBm
3 rd order input intercept point	IIP3lna	400 kHz spacing, P _{IN} = -30 dBm/tone	+6.0	+7.5		dBm
Input return loss	IS11 LNA		10	20		dB
Output return loss	IS22ILNA		10	15		dB
Non-harmonic spurious (Note 4) (Note 5)	PSPUR_LNA	VSWR 10:1, all phases			-50	dBm
LNA_IN to TSW_TX isolation	IS0TSW		9	14		dB

Note 1: Performance is guaranteed only under the conditions listed in this Table.

² Parameters are characterized under the conditions noted here and production tested under nominal temperature and voltage conditions with guard-banded limits.

³ Total module power supply current.

⁴ Shutdown functionality tested in production. Shutdown current (IQ_SD) production tested to be <50 μA.

Note 2: Parameters are characterized under the conditions noted here and production tested under nominal temperature and voltage conditions with guard-banded limits.

Note 3: Receive mode control voltage logic: CTL1, CTL2, and CTL3 = 10xb (refer to Table 2).

Note 4: Parameter is characterized under the conditions listed in this Table, but is not production tested.

Note 5: Measurement performed with P_{IN} = −30 dBm and spectrum analyzer RBW = 100 kHz for frequencies < 1 GHz or RBW = 1 MHz for frequencies from 1 GHz to 10 GHz. Reported spurious maximum value is the noise floor of the spectrum analyzer.

Table 7. SKY65346-21 Electrical Specifications: LNA_IN to RFIO Receive Path – Bypass Mode 1,2,3 (VCC1 = VCC2 = VDD = 3.3 V, Tc = -40 to +85 °C, f= 928 MHz, CW Input, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Loss	LBYP			2.5	3.0	dB
1 dB input compression point ⁴	IP1dB _{BYP}	1 dB gain compression		+20		dBm
Third order input intercept point	IIРЗ _{ВУР}	400 kHz spacing, P _{IN} = −10 dBm/tone	+16	+21		dBm
Input return loss	IS11IBYP		9.5	12.7		dB
Output return loss	IS22IBYP		7.0	8.2		dB

Performance is guaranteed only under the conditions listed in this table.

Table 8. SKY65346-21 Electrical Specifications: ANT1/ANT2 to ASW_RX Receive Path 1,2,3 (VCC1 = VCC2 = VDD = 3.3 V, Tc = -40 to +85 °C, f= 928 MHz, CW Input, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Switch loss	LANT			0.8	1.0	dB
1 dB input compression point ⁴	IP1dBant	1 dB gain compression		+30		dBm
Third order input intercept point	IIP3ant	400 kHz spacing, P _{IN} = -10 dBm/tone	+44	+47		dBm
Input return loss	IS11IANT		10	19		dB
Output return loss	IS22IANT		10	18		dB
ANT1 to ANT2 isolation	ISO _{ANT}		20.5	22.1		dB

¹ Performance is guaranteed only under the conditions listed in this table.

² Parameters are characterized under the conditions noted here and production tested under nominal temperature and voltage conditions with guard-banded limits.

 $^{^{3}}$ Receive mode control voltage logic: CTL1, CTL2, and CTL3 = 11xb (refer to Table 2).

⁴ Parameter is characterized under the conditions listed in this Table, but is not production tested.

² Parameters are characterized under the conditions noted here and production tested under nominal temperature and voltage conditions with guard-banded limits.

 $^{^3}$ Receive mode control voltage logic: CTL1, CTL2, and CTL3 = 1xxb (refer to Table 2).

⁴ Parameter is characterized under the conditions listed in this Table, but is not production tested.

Table 9. SKY65346-21 Electrical Specifications: PA_IN to ANT1/ANT2 Transmit Path 1,2,3 (VCC1 = VCC2 = VDD = 3.3 V, Tc = -40 to +85 °C, f= 928 MHz, CW Input, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
PA small signal gain	Gтx		32.0	33.7	37.5	dB
PA saturated output power	PSAT			+26.3		dBm
PA output power	Роит	$P_{IN} = -6 \text{ dBm}$	+24	+25		dBm
Power-added efficiency	PAE	Pin = -6 dBm		43		%
2 nd harmonic	2fo	$P_{IN} = -6 \text{ dBm}$		-30	-23	dBc
3 rd harmonic	3fo	Pin = -6 dBm		-55	-50	dBc
4 th harmonic	4fo	$P_{IN} = -6 \text{ dBm}$		-67	-58	dBc
5 th harmonic	5fo	$P_{IN} = -6 \text{ dBm}$		- 75	-60	dBc
Input return loss	IS11ITX		9	11		dB
Output return loss	IS22ITX		7	10		dB
Noise Ffigure	NFTX	100 kHz bandwidth		3.4	7.0	dB
Non-harmonic spurious ⁴	Pspur_tx	VSWR 0:1, all phases			-50	dBm

Performance is guaranteed only under the conditions listed in this table.

Table 10. SKY65346-21 Electrical Specifications: RFIO to TSW_TX Transmit Path 1,2,3 (VCC1 = VCC2 = VDD = 3.3 V, Tc = -40 to +85 °C, f= 928 MHz, CW Input, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Loss	LTSW			1.5	3.1	dB
1 dB output compression point (Note 4)	OP1dB _{TSW}	1 dB gain compression		+20		dBm
Third order output intercept point	OIP3TSW	400 kHz spacing, P _{IN} = −10 dBm/tone	+27	+30		dBm
Input return loss	IS11ITSW			8.9		dB
Output return loss	IS22ITSW			11.5		dB

Performance is guaranteed only under the conditions listed in this table.

² Parameters are characterized under the conditions noted here and production tested under nominal temperature and voltage conditions with guard-banded limits.

³ Transmit mode control voltage logic: CTL1, CTL2, and CTL3 = 01xb (refer to Table 2).

⁴ Parameter is characterized under the conditions listed in this Table, but is not production tested. Measurement performed with spectrum analyzer RBW = 100 kHz for frequencies < 1 GHz or RBW = 1 MHz for frequencies from 1 GHz to 10 GHz.

² Parameters are characterized under the conditions noted here and production tested under nominal temperature and voltage conditions with guard-banded limits.

 $^{^3}$ Transmit mode control voltage logic: CTL1, CTL2, and CTL3 = 01xb (refer to Table 2).

⁴ Parameter is characterized under the conditions listed in this Table, but is not production tested.

Typical Performance Characteristics

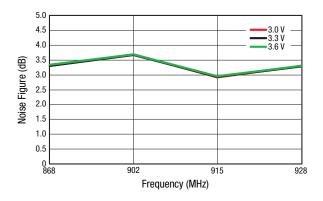


Figure 3. Transmit Path PA_IN to ANT1/ANT2 Noise Figure vs Frequency Over Supply Voltage

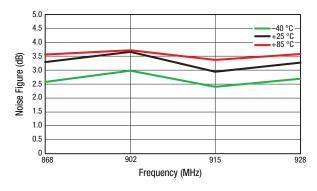


Figure 4. Transmit Path PA_IN to ANT1/ANT2 Noise Figure vs Frequency Over Temperature

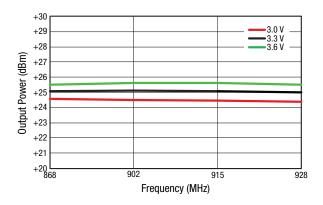


Figure 5. Transmit Path PA_IN to ANT1/ANT2 Output Power vs Frequency Over Supply Voltage

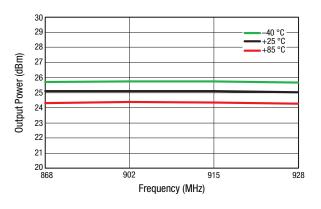


Figure 6. Transmit Path PA_IN to ANT1/ANT2 Output Power vs Frequency Over Temperature

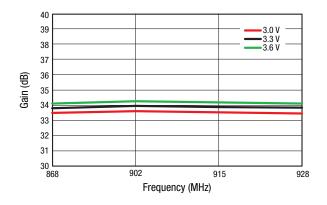


Figure 7. Transmit Path PA_IN to ANT1/ANT2 Gain vs Frequency
Over Supply Voltage

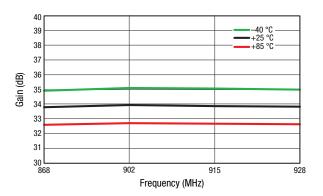


Figure 8. Transmit Path PA_IN to ANT1/ANT2 Gain vs Frequency
Over Temperature

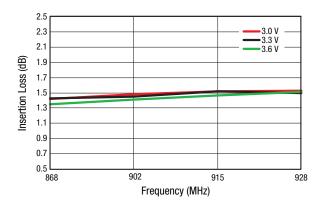


Figure 9. Transceiver Switch Insertion Loss (RFIO to TSW_TX) vs Frequency Over Supply Voltage

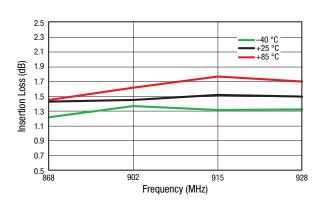


Figure 10. Transceiver Switch Insertion Loss (RFI0 to TSW_TX) vs Frequency Over Temperature

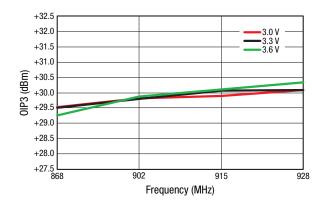


Figure 11. Transceiver Switch OIP3 (RFIO to TSW_TX) vs Frequency Over Supply Voltage

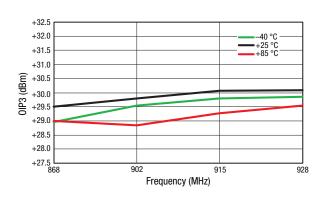


Figure 12. Transceiver Switch OIP3 (RFIO to TSW_TX) vs Frequency Over Temperature

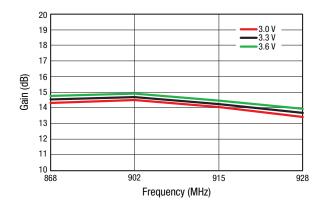


Figure 13. Receive Path Gain (LNA_IN to RFIO) vs Frequency Over Supply Voltage

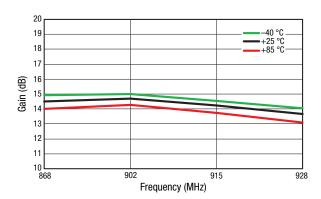


Figure 14. Receive Path Gain (LNA_IN to RFIO) vs Frequency Over
Temperature

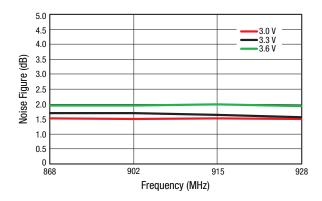


Figure 15. Receive Path Noise Figure (LNA_IN to RFIO) vs Frequency Over Supply Voltage

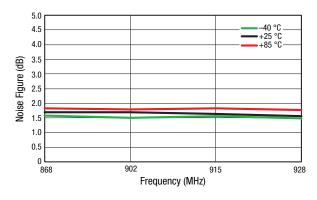


Figure 16. Receive Path Noise Figure (LNA_IN to RFIO) vs Frequency Over Temperature

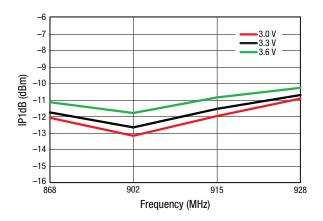


Figure 17. Receive Path IP1dB (LNA_IN to RFIO) vs Frequency Over Supply Voltage

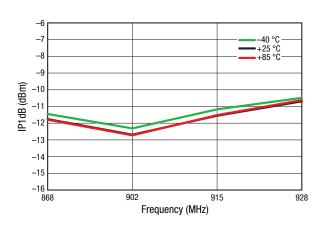


Figure 18. Receive Path IP1dB (LNA_IN to RFIO) vs Frequency
Over Temperature

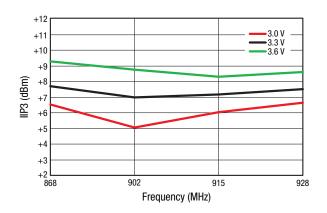


Figure 19. Receive Path IIP3 (LNA_IN to RFIO) vs Frequency Over Supply Voltage

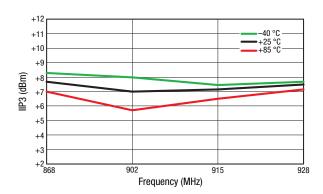


Figure 20. Receive Path IIP3 (LNA_IN to RFIO) vs Frequency Over Temperature

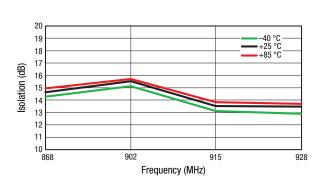


Figure 21. Receive Path Isolation (LNA_IN to TSW_TX) vs Frequency Over Temperature

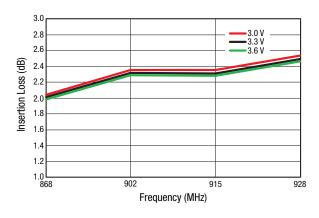


Figure 22. Receive Bypass Mode Insertion Loss (LNA_IN to RFIO)
vs Frequency Over Supply Voltage

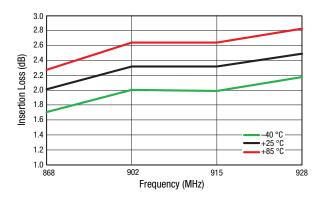


Figure 23. Receive Bypass Mode Insertion Loss (LNA_IN to RFIO) vs Frequency Over Temperature

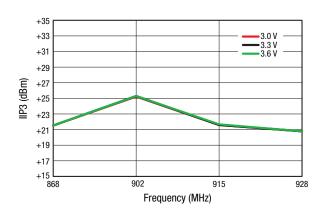


Figure 24. Receive Bypass Mode IIP3 (LNA_IN to RFIO) vs Frequency Over Supply Voltage

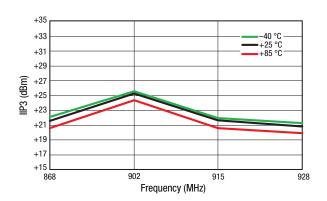


Figure 25. Receive Bypass Mode IIP3 (LNA_IN to RFIO) vs Frequency Over Temperature

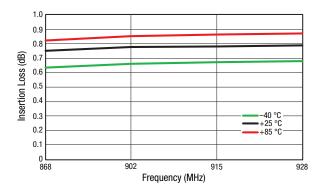


Figure 26. Receive Path Switch Loss (ANT1/ANT2 to ASW_RX) vs Frequency Over Temperature

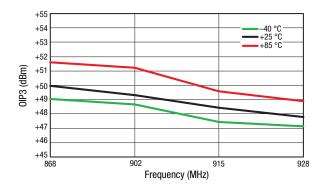


Figure 27. Receive Path OIP3 (ANT1/ANT2 to ASW_RX) vs Frequency Over Temperature

Evaluation Board Description

The SKY65346-21 Evaluation Board is used to test the performance of the SKY65346-21 FEM. An Evaluation Board schematic diagram is provided in Figure 28. An assembly drawing for the Evaluation Board is shown in Figure 29 and the layer detail is provided in Figure 30.

Circuit Design Configurations

The following design considerations are general in nature and must be followed regardless of final use or configuration:

- Paths to ground should be made as short as possible.
- The ground pads of the SKY65346-21 have special electrical and thermal grounding requirements. These pads are the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground pads to dissipate the maximum wattage produced by the circuit board. Multiple vias to the grounding layer are required.
- Two external output bypass capacitors (10 nF and 100 pF) are required on pin 23 (VCC2). The same two capacitor values are also required on pin 9 (VCC1). The capacitors should be placed in parallel between the supply line and ground.
- Pins 9 and 23 (VCC1 and VCC2, respectively) may be connected together at the supply.

NOTE: A poor connection between the slug and ground increases junction temperature (T_J), which reduces the lifetime of the device.

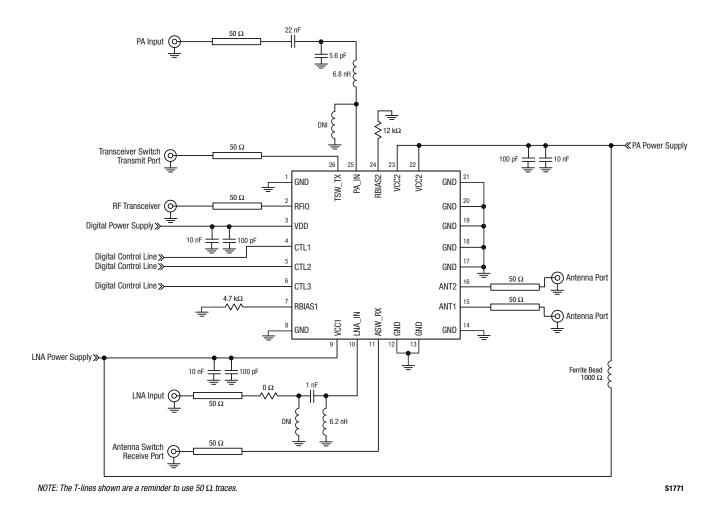


Figure 28. SKY65346-21 Evaluation Board Schematic

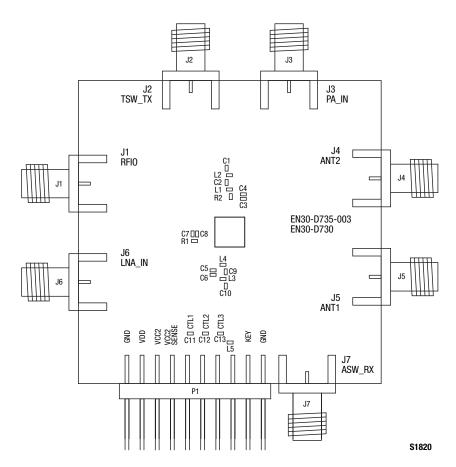
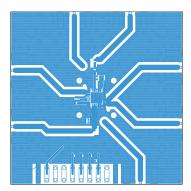
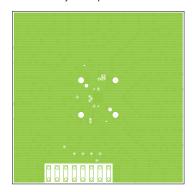


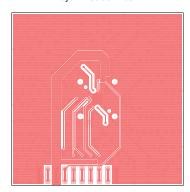
Figure 29. SKY65346-21 Evaluation Board Assembly Diagram



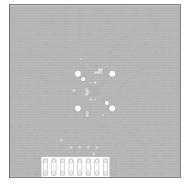
Layer 1: Top - Metal



Layer 1: Solder Mask



Layer 2: Ground



Layer 4: Solid Ground Plane

S1821

Figure 30. SKY65346-21 Evaluation Board Layer Detail

Package Dimensions

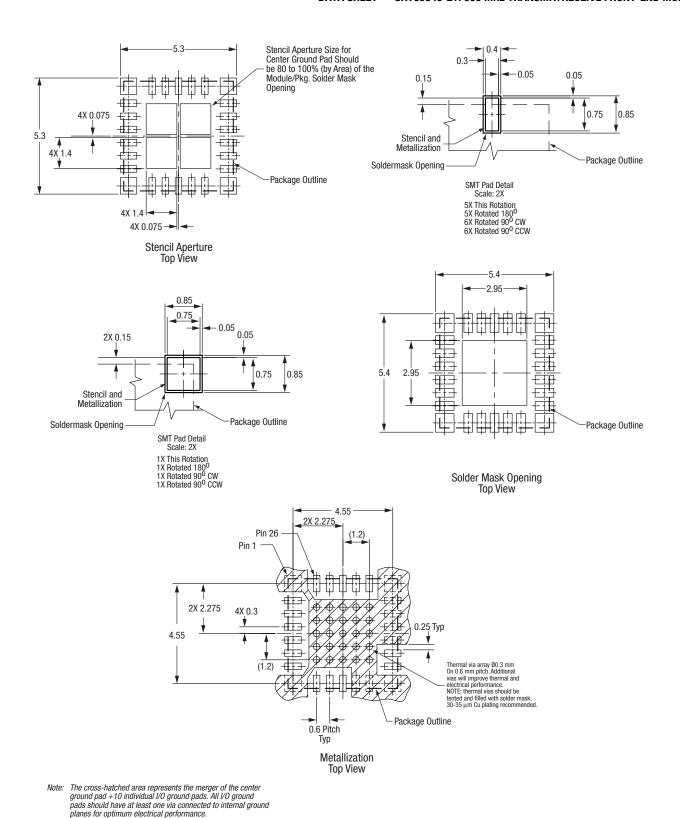
The PCB layout footprint for the SKY65346-21 is provided in Figure 31. Typical part markings are shown in Figure 32. Package dimensions are shown in Figure 33, and tape and reel dimensions and provided in Figure 34.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65346-21 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



All dimensions are in millimeters

Figure 31. SKY65346-21 PCB Layout Footprint

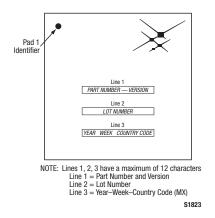


Figure 32. Tyical Part Markings (Top View)

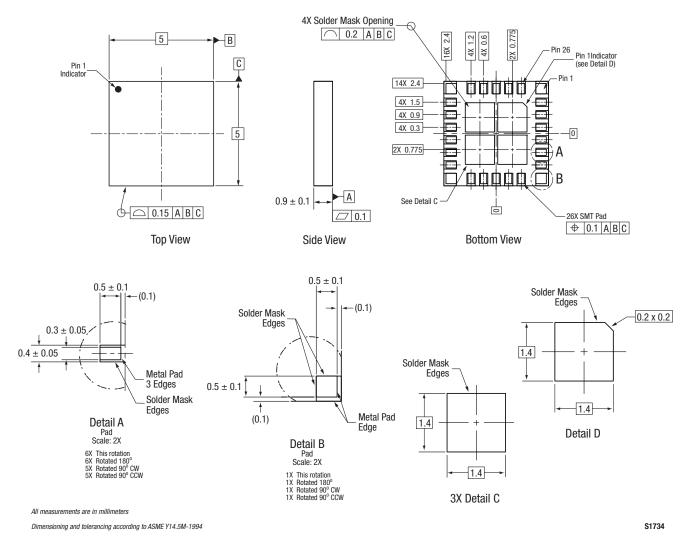


Figure 33. SKY65346-21 Package Dimensions

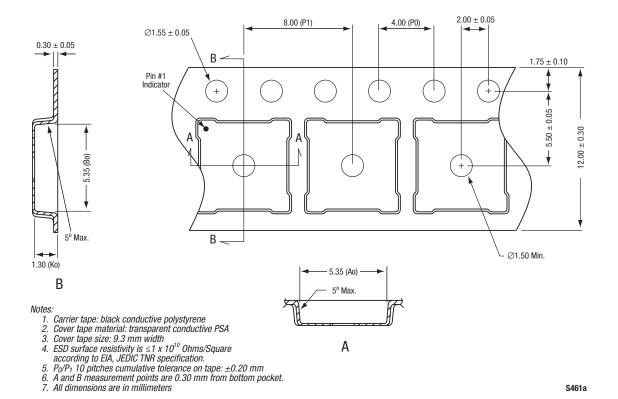


Figure 34. SKY65346-21 Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY65346-21 900 MHz T/R FEM	SKY65346-21	SKY65346-21EK1

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